

Media Release**REVEZ CORPORATION PARTNERS NANYANG POLYTECHNIC TO DRIVE INNOVATIONS IN 5G, AI AND DIGITAL ENGINEERING**

This marks REVEZ's first strategic alliance with a leading polytechnic in Singapore to support the growth of digital talents and drive adoption for digital innovations.

Singapore, 21 June 2021 – [REVEZ Corporation Ltd](#) (REVEZ) and [Nanyang Polytechnic](#) (NYP) have signed a 3-year Memorandum of Understanding (MoU) on 04 June 2021 to drive innovation and collaboration through a series of joint-development projects, cross-training opportunities and student internships. Both parties will work closely in areas of mutual interest, which includes Industrial Internet of Things (IoT), Data Science & Engineering, Machine Learning & Artificial Intelligence, Augmented, Virtual & Mixed Reality, 5G, Enterprise, Cloud & Mobile Computing and Cybersecurity.

This MOU is an important step as it brings and accelerates the launch of commercially ready digital solutions in 5G, AI and Digital Engineering to the market. As part of the MOU, REVEZ will co-develop and co-innovate with NYP to advance new knowledge and develop authentic use cases for industry adoption and case studies for training.

Mr. Victor Neo, Deputy Board Chairman and Group CEO of REVEZ Corporation Ltd, said, "We are proud to be a strategic partner to explore the growth and execution of digital innovations within our domain expertise as we support NYP's transformational role in today's digital economy. We look forward to a fruitful collaboration where REVEZ can offer practical knowledge and skills in architecting and developing end-to-end digital solutions, as well as other opportunities to realise innovation synergies."

Ms. Jeanne Liew, Principal and CEO of Nanyang Polytechnic said: "At Nanyang Polytechnic, we have always valued strategic industry partnerships that offers value-add to our students. Our specialist centres, set up together with leading industry players, are also well-equipped to support companies to leverage industry standard tools and techniques to solve real-world problems. With this partnership with REVEZ, we are confident that the exposure and hands-on experiences in developing digital solutions powered by latest technologies such as 5G and artificial intelligence will give our students an edge."

REVEZ is known for its industry-leading innovations and projects in the immersive multimedia and deep tech (specifically in IoT and AI) spaces. Awarded as the “Largest Provider of Customised Multimedia Solutions for Museums and Galleries” by Singapore Book of Records in 2018, REVEZ is the creator of many engaging and technologically advanced projects, including the Coast-to-Coast (C2C) mobile app, NParks' first augmented reality (AR)-enabled mobile application. With the accelerated demand in digital innovations, REVEZ and its in-house R&D lab, [iOiO Lab](#) continue to pioneer innovations and turnkey solutions for enterprises to excel in the digital age.

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About REVEZ Corporation Ltd.

REVEZ Corporation Ltd. is a CreativeTech group incorporating innovators, technologists and creative capabilities to drive enterprise and consumer value across its 7 business segments. Leveraging their network of Fortune 500 partners and industry experts, they are known for their expertise in Immersive Multimedia, Information and Communications Technology (ICT), Cybersecurity, Deep Tech - specialising in Artificial Intelligence (AI), Internet of Things (IoT), Smart Integrated Spaces, Industrial Automation and Digital Media Networks. Since its incorporation in 2010, the group has worked with more than 100 clients in the private and public sectors on over 500 projects regionally. REVEZ Corporation Ltd continues to shape the digital future with scalable tech adoption, enabling strategic partners to build a robust digital ecosystem and stay ahead of evolving trends. For more information, please visit <https://revezcorp.com>.

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